

UNITED STATES EPARTMENT OF COMMERCE Patent and Trademark Office

Address: COMMISSIONER OF PATENTS AND TRADEMARKS

Washington, D.C. 20231

APPLICATION NO. FILING DATE FIRST NAMED INVENTOR ATTORNEY DOCKET NO. 09/496,794 02/02/00 MOORE J MICT-0005-Di **EXAMINER** MM91/0328 Trop Pruner & Hu DWENS. D **ART UNIT** PAPER NUMBER 8554 Katy Freeway Suite 100 Houston TX 77024 2811 **DATE MAILED:** 03/28/01

Please find below and/or attached an Office communication concerning this application or proceeding.

Commissioner of Patents and Trademarks

	Application No.	Applicant(s)
Office Action Summary	09/496,794	MOORE ET AL.
	Examiner	Art Unit
	Douglas W Owens	2811
The MAILING DATE of this communication appears on the cover sheet with the correspondence address Period for Reply		
A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) FROM THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.136 (a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, a reply within the statutory minimum of thirty (30) days will be considered timely. - If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication. - Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). - Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b). Status		
1) Responsive to communication(s) filed on	·	
2a) ☐ This action is FINAL . 2b) ☑ Thi	s action is non-final.	
3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.		
Disposition of Claims		
4)⊠ Claim(s) <u>26-34</u> is/are pending in the application.		
4a) Of the above claim(s) is/are withdrawn from consideration.		
5) Claim(s) is/are allowed.		
6)⊠ Claim(s) <u>26-34</u> is/are rejected.		
7) Claim(s) is/are objected to.		
8) Claims are subject to restriction and/or election requirement.		
Application Papers		
9) The specification is objected to by the Examiner.		
10) The drawing(s) filed on is/are objected to by the Examiner.		
11) ☐ The proposed drawing correction filed on is: a) ☐ approved b) ☐ disapproved.		
12) The oath or declaration is objected to by the Examiner.		
Priority under 35 U.S.C. \$ 119		
13) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. ≰ 119(a)-(d) or (f).		
a) ☐ All b) ☐ Some * c) ☐ None of:		
1. Certified copies of the priority documents have been received.		
2. Certified copies of the priority documents have been received in Application No		
3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).		
* See the attached detailed Office action for a list of the certified copies not received. 14) Acknowledgement is made of a claim for domestic priority under 35 U.S.C. § 119(e).		
14) Acknowledgement is made of a claim for domestic priority under 55 0.5.0. § 113(e).		
Attachment(s)		
15) Notice of References Cited (PTO-892)	18) 🔲 Interview Summan	/ (PTO-413) Paper No(s)
16) Notice of Draftsperson's Patent Drawing Review (PTO-948) 17) ☐ Information Disclosure Statement(s) (PTO-1449) Paper No(s) _	19) Notice of Informal	Patent Application (PTO-152)

.Application/Control Number: 09/496,794

Art Unit: 2811

DETAILED ACTION

Claim Rejections - 35 USC § 103

- 1. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 2. Claims 26-34 are rejected under 35 U.S.C. 103(a) as being unpatentable over US patent No. 5,868,870 to Fazan et al.

Regarding claims 26-30, Fazan et al. teaches a semiconductor structure, comprising:

- a support (1);
- a first material (2) having a first etch rate;
- a trench formed through the first material and into the support; and
- a trench filler material (4) having an etch rate.

Fazan et al. teaches a pad oxide that is deposited on the substrate (Col. 2, lines 59-61) and a CVD, TEOS or similar filler material is used in the trench. Fazan et al. does not explicitly teach a trench filler material that has an etch rate that is similar to or less than that of the first material. Since Fazan et al. teaches that the pad oxide is deposited, one of ordinary skill in the art would have been left to choose a conventional method of depositing the pad oxide, such as CVD or TEOS. It is apparent that a CVD or TEOS first material would have had the same etch rate as that of a CVD or TEOS

Application/Control Number: 09/496,794

Art Unit: 2811

K.

filler material. It would have been obvious to one of ordinary skill in the art to select CVD oxide or TEOS for the first material as a matter of design choice.

Regarding claim 31, Fazan et al. teaches semiconductor structure having a trench, comprising:

a trench filler (4) material; and

at least a portion of a second material (5) deposited on the trench filler material.

Fazan et al. does not explicitly teach performing an anneal of the second material. It is inherent that an anneal would have been performed on a portion of the second material during subsequent thermal processes.

Regarding claim 32, Fazan et al. teaches a second material that comprises TEOS, CVD oxide or other materials. Fazan et al. teaches a pad oxide that is deposited on the substrate. Fazan et al. does not explicitly teach a trench filler material that has an etch rate that is similar to or less than that of the first material. Since Fazan et al. teaches that the pad oxide is deposited, one of ordinary skill in the art would have been left to choose a conventional method of depositing the pad oxide, such as CVD or TEOS. It is apparent that a CVD or TEOS first material would have had the same etch rate as that of a CVD or TEOS second material. It would have been obvious to one of ordinary skill in the art to select CVD oxide or TEOS for the first material as a matter of design choice.

Regarding claim 33, Fazan et al. teaches a semiconductor device, wherein the trench filler material and second material include silicon dioxide.

.Application/Control Number: 09/496,794

Art Unit: 2811

Page 4

Regarding claim 34, Fazan et al. does not explicitly teach a second material that has a portion that is thermally grown. It is inherent that a portion of the second material would have grown during subsequent thermal processes.

Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Douglas W Owens whose telephone number is 703-308-6167. The examiner can normally be reached on Monday-Friday.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Tom Thomas can be reached on 703-308-2772. The fax phone numbers for the organization where this application or proceeding is assigned are 703-308-7722 for regular communications and 703-308-7722 for After Final communications.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is 703-308-0956.

DWO March 23, 2001 Steven Loke Primary Examiner